



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Yasunori INOUE, et al.

Group Art Unit: Unassigned

Serial Number: 08/921,250

Examiner: Unassigned

Filed: August 29, 1997

For: FABRICATION METHOD OF SEMICONDUCTOR DEVICE
AND ABRASIVE LIQUID USED THEREIN

PRELIMINARY AMENDMENT

RECEIVED

Assistant Commissioner for Patents
Washington, D.C. 20231

JAN 22 1998

JAN 29 1998

January 22, 1998

Sir:

This is a Preliminary Amendment for the above-captioned patent application. Please amend the above-captioned patent application as follows:

IN THE SPECIFICATION:

Page 8, line 17, change " °C " to -- ° --.

Page 9, line 25, change " °C " to -- ° --.

Page 12, line 10, change " semiconductor " to -- semiconductor device --.

Page 16, line 21, change " SO film 7 " to -- SOG film 7 --.